# Clock OSC SG5032VAN

Product name SG5032VAN 156.250000MHz KCBA
Product Number / Ordering code X1G0042610071xx

Please refer to the 9.Packing information about xx (last 2 digits)

Output waveform LVDS

Pb free / Complies with EU RoHS directive

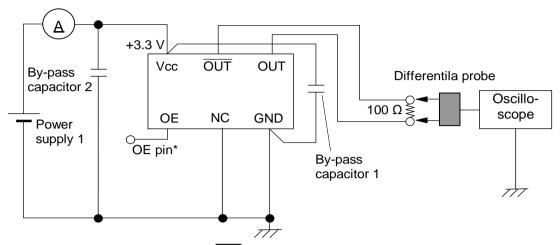
Reference weight Typ. 52 mg

1.Absolute maximum ratings								
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions / Remarks		
Maximum supply voltage	Vcc-GND	-0.3	-	+4	V	-		
Storage temperature	T_stg	-40	-	+125	°C	Storage as single product		
Input voltage	Vin	-0.3	-	Vcc+0.3	V	OE Terminal		

2.Specifications(character		1		1	1	lo 1111 (D	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions / Remarks	
Output frequency	f0	-	156.2500	-	MHz		
Supply voltage	Vcc	2.25	-	3.63	V	-	
Operating temperature	T_use	-20	-	+70	°C	-	
Frequency tolerance	f_tol	-20	-	20	x10 <sup>-6</sup>	-	
Current consumption	Icc	-	-	30	mA	OE = Vcc, L_LVDS = 100 Ω	
Stand-by current	I_std	-	-	-	mA	-	
Disable current	l_dis	-	-	20.0	mA	OE = GND	
Symmetry	SYM	45	-	55	%	At output crossing point	
Output voltage(LVDS)	Vod	250	-	450	mV	-	
	dVop	-	-	50	mV	1-	
	Vos	1.15	-	1.35	V	1-	
	dVos	-	-	150	mV	1-	
Output load condition(LVDS)	L_LVDS	-	100	-	Ω	Connected between OUT and ŌŪT	
Input voltage	V <sub>IH</sub>	70 % Vcc	-	-		-	
	V <sub>IL</sub>	-	-	30 % Vcc		1-	
Rise time	t <sub>r</sub>	-	-	300	ps	-	
Fall time	tf	-	-	300	ps	-	
Start-up time	t_str	-	-	3	ms	-	
Jitter	t <sub>DJ</sub>	-	6.9	-	ps	Deterministic Jitter Vcc=2.5V	
	$T_{RJ}$	-	1.1	-	ps	Random Jitter Vcc=2.5V	
	t <sub>RMS</sub>	-	5.6	-	ps	δ(RMS of total distribution) Vcc=2.5V	
	t <sub>p-p</sub>	-	22.3	-	ps	Peak to Peak Vcc=2.5V	
	t <sub>acc</sub>	-	1	-	ps	Accumulated Jitter(δ) n=2 to 50000 cycles Vcc=2.5V	
Phase jitter	t <sub>PJ</sub>	-	0.3	-	ps	Offset Frequency: 12kHz to 20MHz Vcc=2.5V	
Phase noise	L(f)	-	-43	-	dBc/Hz	Offset 1Hz Vcc=2.5V	
		-	-76	-	dBc/Hz	Offset 10Hz Vcc=2.5V	
		-	-104	-	dBc/Hz	Offset 100Hz Vcc=2.5V	
		-	-122	-	dBc/Hz	Offset 1kHz Vcc=2.5V	
		-	-131	-	dBc/Hz	Offset 10kHz Vcc=2.5V	
		-	-137	-	dBc/Hz	Offset 100kHz Vcc=2.5V	
		-	-137	-	dBc/Hz	Offset 1MHz Vcc=2.5V	
Frequency aging	f_age	-5	-	5	x10 <sup>-6</sup> /Year	25 °C, 1st year	
		_	-	_		-	

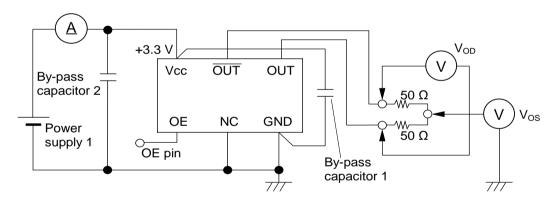
#### 3.Test circuit

1) To observe waveform and current (case 1)



- \* The lines from OUT and OUT pin are same length.
- \* To measure the disable current, OE pin is connected to GND

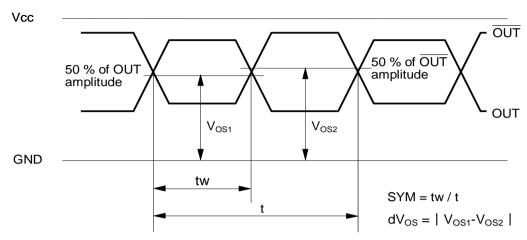
# 2) To observe waveform and current (case 2)



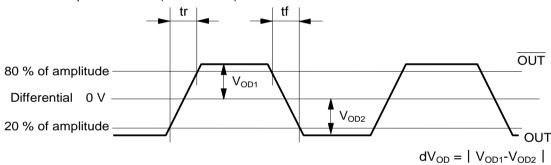
- \* The lines from OUT and OUT pin are same length.
- 3) Measurement condition
- A) Oscilloscope
- •Bandwidth should be 5 times higher than DUT's output frequency (4 GHz).
- •Probe ground should be placed closely from test point and lead length should be as short as possible.
- B) By-pass capacitor 1 (approx. 0.01  $\mu F$  to 0.1  $\mu F$ ) places closely between Vcc and GND.
- C) By-pass capacitor 2 (approx. 10  $\mu F$ ) places closely between power supply terminals on the board.
- D) Use the current meter whose internal impedance value is small.
- E) Power supply
- Start up time (0 Vg90 %Vcc) of power source should be more than 150  $\mu$ s and slew rate should be less than 19.8 mV/ $\mu$ s.
- Impedance of power supply should be as low as possible.

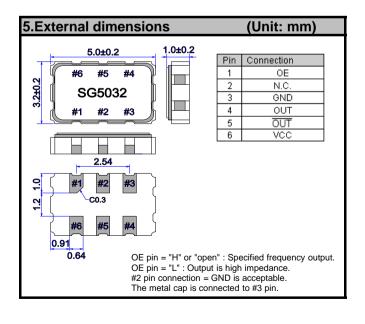
# 4. Timing chart

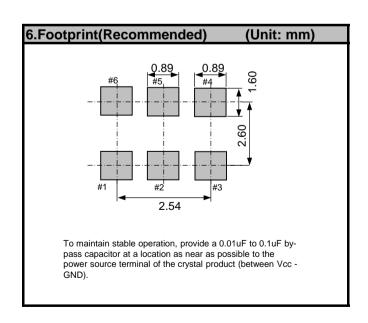
Each output waveform (OUT, and OUT)

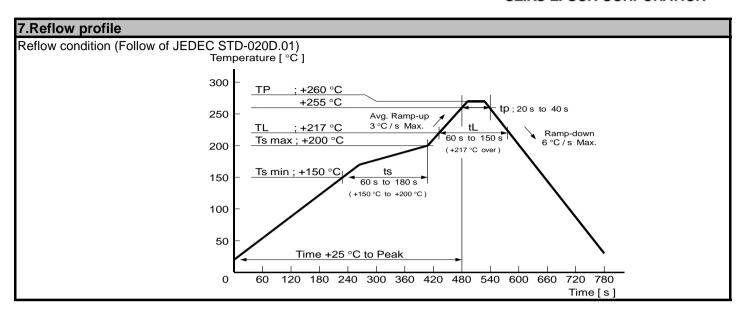


Differential output waveform (OUT - OUT)







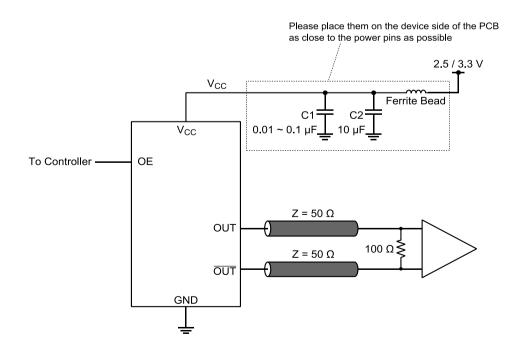


#### 8. Example of schematic layout

This figure shows an example of this product's application schematic.

As with any high speed analog circuitry, the power supply pins for this device are vulnerable to noise. In order to achieve optimum jitter performance, power isolation with filter device is required for power supply pins.

In order to achieve best performance of the power isolation filter, it is recommended that the filter composing devices is placed on the device side of the PCB as close to the power pins as possible. The component value of this filter is just an example, it may have to be adjusted.



- $^*$  By-pass capacitor (approx. 0.01  $\mu F$  to 0.1  $\mu F)$  places closely between Vcc and GND.  $^*$  By-pass capacitor (approx. 10  $\mu F)$  places closely between power supply terminals on the board.  $^*$  Please design the two output lines by characteristic impedance 100  $\Omega$  and same length, and try to make the output lines as short as possible.

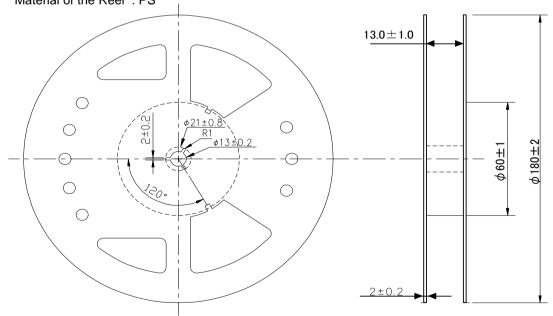
9.Packing	Packing information							
[1]Produc	t number la	ast 2 digits code(xx) description	The recommended code is "00"					
	X1G0042	610071xx						
	Code	Condition	Code	Condition				
	01	Any Q'ty vinyl bag(Tape cut)	13	500pcs / Reel				
	11	Any Q'ty / Reel	00	1000pcs / Reel				
	12	250pcs / Reel						

# **SEIKO EPSON CORPORATION** [ 2 ] Taping specification Subject to EIA-481 & IEC-60286 (1) Tape dimensions Material of the Carrier Tape: PS Material of the Top Tape : PET+PE Unit: mm 0 0 0 0 0 Carrier tape Top tape

I	Symbol	Α	В	С	D	E	F	G	Н
	Value	φ1.5	4.0±0.1	8.0±0.1	7.25±0.2	12.0±0.2	1.40±0.1	3.5±0.1	5.4±0.1
		+0.1/-0							

# (2) Reel dimensions

Center material : PS Material of the Reel: PS



# 10.Notice

- This material is subject to change without notice.
- Any part of this material may not be reproduced or duplicated in any form or any means without the written permission of Seiko Epson.
- The information about applied circuitry, software, usage, etc. written in this material is intended for reference only. Seiko Epson does not assume any liability for the occurrence of infringing on any patent or copyright of a third party. This material does not authorize the licensing for any patent or intellectual copyrights.
- When exporting the products or technology described in this material, you should comply with the applicable export control laws and regulations and follow the procedures required by such laws and regulations.
- You are requested not to use the products (and any technical information furnished, if any) for the development and/or manufacture of weapon of mass destruction or for other military purposes. You are also requested that you would not make the products available to any third party who may use the products for such prohibited purposes.
- These products are intended for general use in electronic equipment. When using them in specific applications that require
  extremely high reliability, such as the applications stated below, you must obtain permission from Seiko Epson in advance.
  - / Space equipment (artificial satellites, rockets, etc.)
  - / Transportation vehicles and related (automobiles, aircraft, trains, vessels, etc.)
  - / Medical instruments to sustain life
  - / Submarine transmitters
  - / Power stations and related
  - / Fire work equipment and security equipment
  - / Traffic control equipment
  - / And others requiring equivalent reliability.
- All brands or product names mentioned herein are trademarks and/or registered trademarks of their respective.

# 11.Contact us

http://www5.epsondevice.com/en/contact/